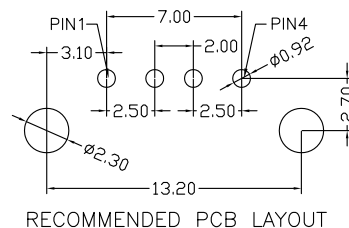
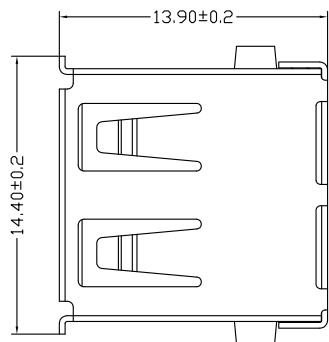
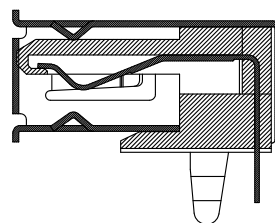
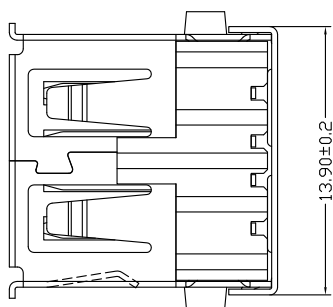
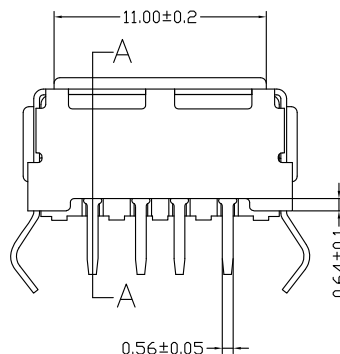
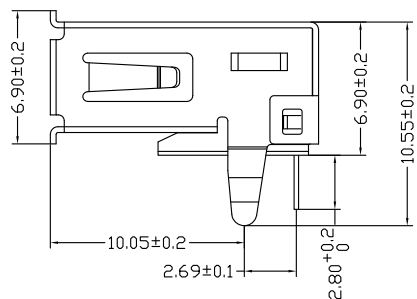
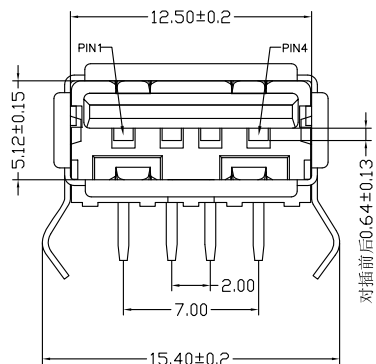


The product using material and processing must conform to the "WI-PZ-001" HSF technical standard control requirements

RoHS



- NOTE:
- MATERIAL SPECIFICATION:
 - 1-1.HOUSING:LCP ULV94-0
 - 1-2.CONTACTS:C2680.
 - 1-3.SHELL:COPPER ALLOY
 - PLATING SPECIFICATION:
 - 2-1.CONTACTS: Ni UNDER PLATED OVER ALL. Sn ON SOLDER AREA Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
 - 2-2. SHELL: Ni UNDER PLATED OVER ALL.
 - MECHANICAL PERFORMANCE:
 - 3-1.INSERTION FORCE: 3.57kgf MAX
 - 3-2.REMOVAL FORCE: 1.02kgf MIN
 - 3-3.DURABILITY: 1500 CYCLES.
 - ELECTRICAL PERFORMANCE:
 - 4-1.CURRENT RATING:1.5A
 - 4-2.VOLTAGE RATING:30V MAX
 - 4-3.CONTACT RESISTANCE: 30m Ohm MAX.
 - 4-4.INSULATION RESISTANCE: 1000MΩ MIN
 - 4-5.DIELECTRIC WITHSTANDING VOLTAGE: 500V AC MIN.
 - ENVIRONMENTAL PERFORMANCE:
 - OPERATING TEMPERATURE: -20°C~+85°C.
 - P/N:



剖面 A-A
比例 1:1

- WLU2F9-04 1 X X X 185
- | | | | |
|---------|-----------|---------|----------------|
| PLATED: | 1-G/F | SHELL: | 1-COPPER ALLOY |
| | 2-Au 3u" | COLOUR: | A-BLACK |
| | 5-Au 15u" | | K-WHITE |
| | 6-Au 30u" | | |

REV.	REVISION RECORD	DATE	GENERAL TOLERANCES		SCALE:	NAME	DATE	PART.NO:	DWG.NO:	 WanLian Teconology Co., Ltd	
A0	NEW RELEASE	21.01.13	LINEAR	ANGLES	1:1	Wang_jr	21.01.13	WLU2F9-041XXX185	ENDE05		
			0.0±0.35	X°REF±6°	APPROVED	Han_Gao	21.01.13	TITLE:			
			UNIT:mm	0.00±0.25	X°±3°	DESIGNER	Zijun_Huang	21.01.13	USB2.0 A/F Right angle type DIP		REV: A0
			SIZE: A4	0.000±0.10	X°X' ±2°	DRAWN					